

COMPLIANT

Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
30	0.0039 at V _{GS} = 10 V	30.5	21.5 nC			
	0.0055 at V _{GS} = 4.5 V	25.6	21.5110			

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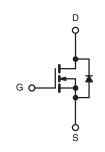
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- Halogen-free
- TrenchFET[®] Power MOSFET
- + 100 % $\rm R_g$ and UIS Tested

APPLICATIONS

- Low-Side DC/DC Conversion
 - Notebook PC
 - Gaming



Top View
Ordering Information: Si4166DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	IGS T _A = 25 °C,	unless othe	erwise noted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	v	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		30.5		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C	1_	24.5		
Continuous Drain Guirent $(1_j = 130^{\circ} \text{ C})$	T _A = 25 °C	I _D	20.5 ^{b, c}		
	T _A = 70 °C		16.5 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	70	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1.	5.9		
	T _A = 25 °C	I _S	2.7 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	30		
Avalanche Energy	L = 0.1 mH		45	mJ	
Maximum Power Dissipation	T _C = 25 °C		6.5		
	T _C = 70 °C		4.2	w	
	T _A = 25 °C	P _D	3.0 ^{b, c}	vv	
	T _A = 70 °C	1	1.9 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	34	41	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	15	19	0/10	

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 80 °C/W.

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SPECIFICATIONS $T_J = 25 \ ^{\circ}C$, Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	,		1	, ,,			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			31		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 5.4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2		2.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 15 A		0.0032 0	0.0039		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		0.0045	0.0055	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		65		S	
Dynamic ^b		1					
Input Capacitance	C _{iss}			2730		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		540			
Reverse Transfer Capacitance	C _{rss}			205			
Tatal Oata Obarra		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		42.5	65	nC	
Total Gate Charge	Q _g			21.5	33		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		6.9			
Gate-Drain Charge	Q _{gd}			7.1			
Gate Resistance	Rg	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-On Delay Time	t _{d(on)}			30	50	- ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		19	35		
Turn-Off Delay Time	t _{d(off)}	$\rm I_D \cong 10$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 Ω		35	60		
Fall Time	t _f			15	30		
Turn-On Delay Time	t _{d(on)}			12	24		
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		9	18		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 10 A, V_GEN = 10 V, R_g = 1 Ω		29	50		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characterist	cs						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			5.9	A	
Pulse Diode Forward Current ^a	I _{SM}				70		
Body Diode Voltage	V _{SD}	I _S = 3 A		0.74	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			28	55	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$\begin{bmatrix} 1 \\ -10 \\ 0 \end{bmatrix}$		21	42	nC	
Reverse Recovery Fall Time	t _a	I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C		15			
Reverse Recovery Rise Time				13		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

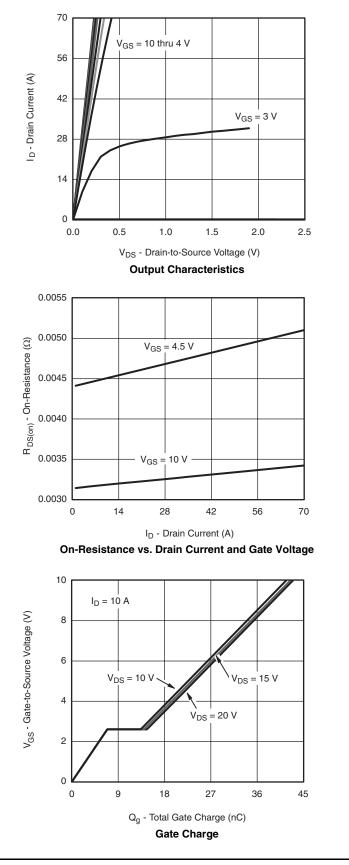
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

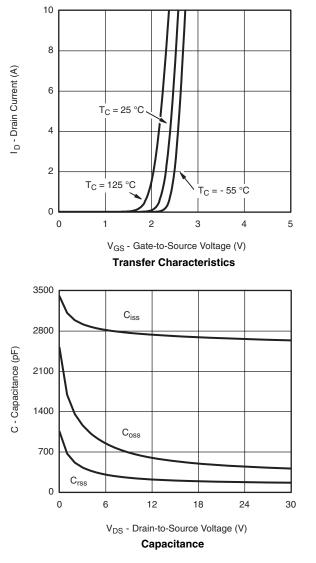


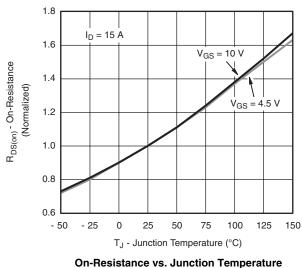


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







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 $I_D = 15 A$

T_J = 125 °C

T_J = 25 °C

8 9 10

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4 5 6

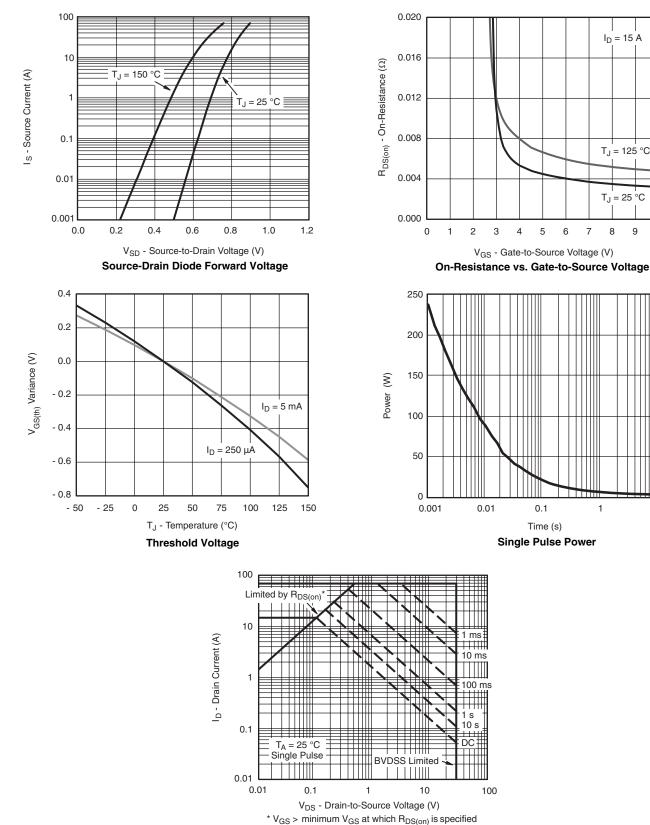
0.1

Time (s) Single Pulse Power

1

10

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



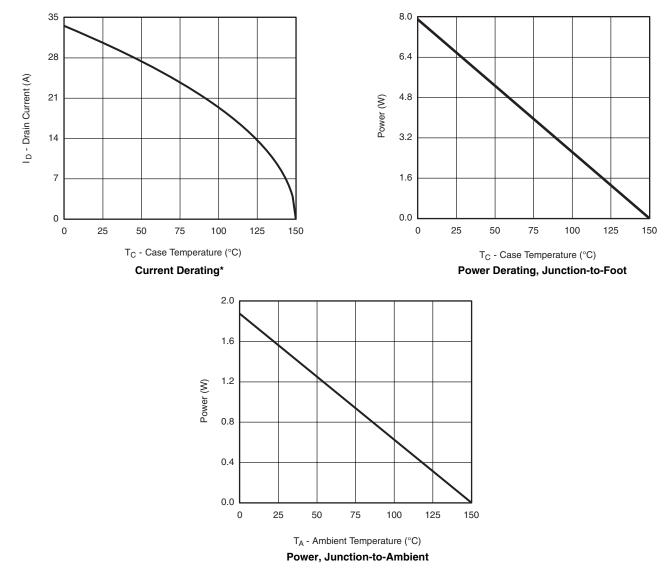
Safe Operating Area, Junction-to-Ambient





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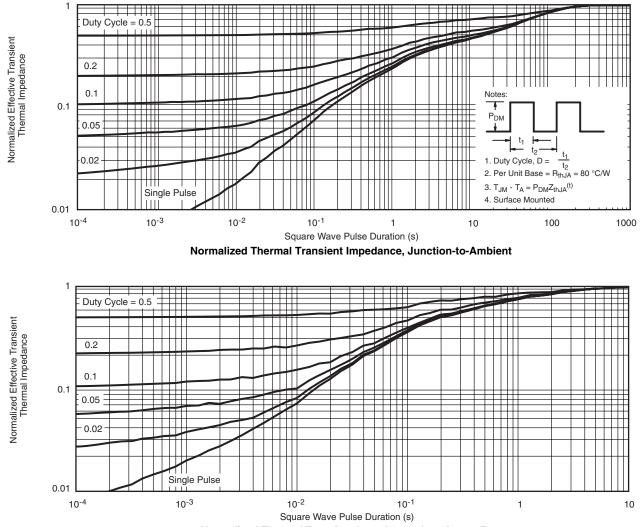


* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68953.

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